

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT						
NATURE OF CONVEYANCE:	ASSIGNMENT						
CONVEYING PARTY DATA							
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>CHEN FENG</td> <td>05/07/2013</td> </tr> <tr> <td>LIANG LIU</td> <td>05/07/2013</td> </tr> </tbody> </table>		Name	Execution Date	CHEN FENG	05/07/2013	LIANG LIU	05/07/2013
Name	Execution Date						
CHEN FENG	05/07/2013						
LIANG LIU	05/07/2013						
RECEIVING PARTY DATA							
Name:	Beijing FUNATE Innovation Technology Co., LTD.						
Street Address:	B1115, RD Plaza, Tsinghua Science Park, Shuangqing Road, Haidian District						
City:	Beijing						
State/Country:	CHINA						
PROPERTY NUMBERS Total: 1							
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>13891060</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	13891060		
Property Type	Number						
Application Number:	13891060						
CORRESPONDENCE DATA							
Fax Number:	7147357469						
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>							
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NAME OF SUBMITTER:	D. Austin Bonderer						
Signature:	/D. Austin Bonderer/						
Date:	05/09/2013						
Total Attachments: 2 source=US51554130507ASM#page1.tif source=US51554130507ASM#page2.tif							

CH \$40.00 13891060

ASSIGNMENT

In consideration of value received, the receipt and sufficiency of which are hereby acknowledged, the undersigned ASSIGNOR(S)

- 1. CHEN FENG , residing at Beijing, China
- 2. LIANG LIU , residing at Beijing, China
- 3. _____ , residing at _____
- 4. _____ , residing at _____
- 5. _____ , residing at _____
- 6. _____ , residing at _____
- 7. _____ , residing at _____
- 8. _____ , residing at _____

hereby sell(s), assign(s) and transfer(s) unto: **BEIJING FUNATE INNOVATION TECHNOLOGY CO., LTD.** having a principal place of business at **B1115, R&D Plaza, Tsinghua Science Park, Shuangqing Road, Haidian District, Beijing, P.R.C.** hereafter designated "ASSIGNEE" the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100, in the invention and all patent applications including any and all divisions, continuations, substitutes, and reissues thereof, and all resulting patents, known as **HEATING FLOOR** for which the undersigned

[] previously executed --- Ser. No. _____ and filing date of _____
[X] is executing concurrently herewith

an application for Letters Patent of United States of America

AND the undersigned hereby authorize(s) and request(s) the United States Commissioner of Patents and Trademarks to issue said Letters Patent to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree(s) that the attorneys of record in said application, if any, shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree(s) to testify and execute any papers for ASSIGNEE, its successors, assigns and legal representatives, deemed essential by ASSIGNEE to ASSIGNEE's full protection and title in and to the invention hereby transferred.

1.	<u>Chen Feng</u> CHEN FENG	<u>May 7, 2013</u> Date
2.	<u>Liang Liu</u> LIANG LIU	<u>May 7, 2013</u> Date
3.	_____	_____ Date
4.	_____	_____ Date
5.	_____	_____ Date
6.	_____	_____ Date
7.	_____	_____ Date
8.	_____	_____ Date
9.	_____	_____ Date